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IN THE CLAIMS

This listing of claims replaces all prior versions and listings of the claims in the abovereferenced application.

- (Currently Amended) A light-emitting device comprising: 1.
- a semiconductor heterostructure structure including at least one p-type layer and one n-type layer; and
- a p contact and an n contact, the p contact electrically connected to the p-type layer, the n contact electrically connected to the n-type layer, wherein at least one of the p and n contacts is a multi-layered contact external to the semiconductor heterostructure structure, the multi-layered contact comprising:
 - a metallic reflector layer;
 - a continuous uniform conducting sheet adjacent to the semiconductor structure, wherein the continuous uniform conducting sheet comprises a metal and that makes ohmic contact to the heterostructure structure; and
 - a conductive barrier layer interposing the reflector layer and the continuous uniform conducting sheet;

wherein the multi-layer contact has a reflectivity greater than 75% for light at an operating wavelength of the light-emitting device.

- 2. (Canceled).
- 3. (Original) A device, as defined in claim 1, wherein the multi-layer contact has a specific contact resistance less than $10^{-2} \Omega$ -cm².
 - 4. (Canceled).
- 5. (Original) A device, as defined in claim 1, wherein the reflector layer has a thickness greater than 500 Å.
 - б. (Currently Amended) A device, as defined in claim 1, wherein the continuous Serial No. 09/469,652

uniform conducting sheet that makes ohmic contact to the heterostructure has a thickness less than 200 Å.

- 7. (Original) A device, as defined in claim 1, wherein the reflector layer is selected from the group consisting of Al, Cu, Rh, Pd, and Au.
- 8. (Currently Amended) A device, as defined in claim 1, wherein the p and n contacts are on opposing faces of the heterostructure semiconductor structure.
- 9. (Currently Amended) A device, as defined in claim 8, wherein the continuous uniform conducting sheet that makes ohmic contact to the heterostructure includes comprises

 Ni and Ag.
- 10. (Currently Amended) A device, as defined in claim 8, wherein the reflector layer is comprises Ag.
- 11. (Currently Amended) A light-emitting semiconductor device comprising: a semiconductor heterostructure structure having at least one p-type and one n-type layer; and

a p contact and an n contact, the p contact electrically connected to the p-type layer, the n contact electrically connected to the n-type layer, wherein at least one of the p and n contacts is a multi-layer contact external to the semiconductor heterostructure structure, the multi-layer contact comprising:

a metallic reflector layer selected from the group of Al, Rh, and Ag; and
a continuous uniform conducting sheet adjacent to the semiconductor structure,
wherein the continuous uniform conducting sheet comprises a metal and that makes
ohmic contact to the heterostructure structure;

wherein the multi-layer contact has a reflectivity greater than 75% for light at an operating wavelength of the light-emitting device and wherein the multi-layer contact has a specific contact resistance less than 10⁻² \Omega-cm².

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12-13. (Canceled).

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- (Currently Amended) A device, as defined in claim 11, the multi-layer contact 14. further comprising a barrier layer interposing the reflector layer and the continuous uniform conducting sheet.
- (Original) A device, as defined in claim 11, the reflector layer having a 15. thickness greater than 500 Å.
- (Currently Amended) A device, as defined in claim 11, wherein the continuous 16. uniform conducting sheet that makes-chmic contact to the heterostructure having has a thickness less than 200 Å.
 - 17. (Canceled).
- 18. (Currently Amended) A device, as defined in claim 11, wherein the continuous uniform conducting sheet that makes chimic contact to the heterostructure is selected from the group that consists of Ti, Au/NiO, and Ni/Au.
- 19. (Currently Amended) A device, as defined in claim 1, wherein the semiconductor heterostructure structure includes at least one III-nitride layer.
- 20. (Currently Amended) A device, as defined in claim 11, wherein the semiconductor heterostructure structure includes at least one III-nitride layer.
- 21. (New) A device, as defined in claim 1, wherein the continuous uniform conducting sheet absorbs less than 25% of light generated in the semiconductor structure and incident on the continuous uniform conducting sheet.
- 22. (New) A device, as defined in claim 19, wherein a voltage required to forward bias the device is less than 3.5 V.
- 23. (New) A device, as defined in claim 1, wherein the continuous uniform conducting sheet has thickness less than 100 Å.
 - 24. (New) A device, as defined in claim 1, wherein:

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the continuous uniform conducting sheet comprises Au and has a thickness less than 35 Å;

the conductive barrier layer comprises Rh and has a thickness less than 50 Å; and the metallic reflector layer comprises Al.

- 25. (New) A device, as defined in claim 8, wherein at least a portion of the n contact overlies at least a portion of the p contact.
- 26. (New) A device, as defined in claim 11, wherein the reflector layer is selected from the group consisting of Al, Cu, Rh, Pd, and Au.
- 27. (New) A device, as defined in claim 11, wherein the multi-layer contact has a specific contact resistance less than $10^{-2} \Omega$ -cm².
- 28. (New) A device, as defined in claim 11, wherein the continuous uniform conducting sheet absorbs less than 25% of light generated in the semiconductor structure and incident on the continuous uniform conducting sheet.
- 29. (New) A device, as defined in claim 20, wherein a voltage required to forward bias the device is less than 3.5 V.
- 30. (New) A device, as defined in claim 11, wherein the continuous uniform conducting sheet has thickness less than 100 Å.
 - 31. (New) A device, as defined in claim 11, wherein:

the continuous uniform conducting sheet comprises a bi-layer of NiO/Au, wherein the NiO has a thickness less than 100 Å and the Au has thickness less than 50 Å;

the metallic reflector comprises Al and has a thickness greater than 1500 Å.

32. (New) A device, as defined in claim 11, wherein:

the continuous uniform conducting sheet comprises Ti and has a thickness less than 30 Å; and

the metallic reflector comprises Al.

GROUP U.F. 2635 N. FIRST ST, SUITR 223 SAN JOSS, CA 95134 (408) 382-0480 PAX (400) 382-0481 33. (New) A device, as defined in claim 11, wherein:

the continuous uniform conducting sheet comprises Rh and has a thickness less than

150 Å; and

the metallic reflector comprises Al.

34. (New) A device, as defined in claim 11, wherein:

the continuous uniform conducting sheet comprises Cu and has a thickness less than

200 Å; and

the metallic reflector comprises Al.

35. (New) A device, as defined in claim 11, wherein:

the continuous uniform conducting sheet comprises Au and has a thickness less than

100 Å; and

the metallic reflector comprises Al.

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